MOSFET – Power, Single, P-Channel, DPAK

-60 V, -15.5 A

Features

- Withstands High Energy in Avalanche and Commutation Modes
- Low Gate Charge for Fast Switching
- AEC Q101 Qualified NTDV20P06L
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Bridge Circuits
- Power Supplies, Power Motor Controls
- DC-DC Conversion

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

	Symbol	Value	Unit		
Drain-to-Source	V _{DSS}	-60	V		
Gate-to-Source	ce Continuous		V _{GS}	±20	V
Voltage	Non-Repetitive	$t_p \le 10 \text{ ms}$	V_{GSM}	±30	
Continuous Drain Current	Steady State	T _C = 25°C	I _D	-15.5	Α
Power Dissipa- tion	Steady State	T _C = 25°C	P _D	65	W
Pulsed Drain Current	t _p = 10	I _{DM}	±50	Α	
Operating Junctio	T _J , T _{STG}	-55 to 175	°C		
Single Pulse Drain Energy (V _{DD} = 25 L = 2.7 mH, R _G =	E _{AS}	304	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	2.3	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	80	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	110	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Surface-mounted on FR4 board using 1 in sq. pad size (Cu area = 1.127 in sq. [1 oz] including traces)
- Surface-mounted on FR4 board using the minimum recommended pad size (Cu area = 0.412 in sq.)

1

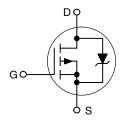


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX (Note 1)
-60 V	130 m Ω @ –5.0 V	–15.5 A

P-Channel



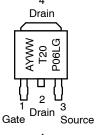
MARKING DIAGRAMS

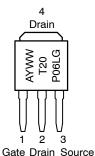


DPAK CASE 369C STYLE 2



PAK/DPAK CASE 369D STYLE 2





20P06L Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS							<u> </u>
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -$	-250 μΑ	-60	-74		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-64		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V.	T _J = 25°C			-1.0	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = -60 \text{ V}$	T _J = 150°C			-10	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$				±100	nA
ON CHARACTERISTICS (Note 3)	•					-	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	–250 μΑ	-1.0	-1.5	-2.0	V
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -5.0 \text{ V}, I_D$	= -7.5 A		0.130	0.150	Ω
		$V_{GS} = -5.0 \text{ V}, I_{D}$	= -15 A		0.143		
Forward Transconductance	9 _{FS}	V _{DS} = -10 V, I _D	= -7.5 A		11		S
Drain-to-Source On-Voltage	V _{DS(on)}	$V_{GS} = -5.0 \text{ V},$ $I_D = -7.5 \text{ A}$	T _J = 25°C			-1.2	V
	,		T _J = 150°C			-1.9	1
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				740	1190	pF
Output Capacitance	C _{OSS}	$V_{GS} = 0 \text{ V, f} = 1 \text{ MHz, } V_{DS} = -25 \text{ V}$			207	300	1
Reverse Transfer Capacitance	C _{RSS}				66	120	1
Total Gate Charge	Q _{G(TOT)}				15	26	nC
Gate-to-Source Charge	Q _{GS}	$V_{GS} = -5.0 \text{ V}, V_{DS}$ $I_{D} = -18 \text{ A}$	_S = -48 V,		4.0		1
Gate-to-Drain Charge	Q_{GD}	ID = -18 A			7.0		1
SWITCHING CHARACTERISTICS (Note 4)						
Turn-On Delay Time	t _{d(ON)}				11	20	ns
Rise Time	t _r	VGS = -5.0 V. VDF	n = -30 V.		90	180	1
Turn-Off Delay Time	t _{d(OFF)}	$V_{GS} = -5.0 \text{ V}, V_{DE}$ $I_D = -15 \text{ A}, R_G = -15 \text{ A}$	= 9.1 Ω		28	50	1
Fall Time	t _f				70	135	
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		•
Forward Diode Voltage	V_{SD}		T _J = 25°C		1.5	2.5	V
		$V_{GS} = 0 \text{ V}, I_{S} = -15 \text{ A}$	T _J = 150°C		1.3		1
Reverse Recovery Time	t _{RR}				60		ns
Charge Time	ta	$V_{GS} = 0 \text{ V, } d_{IS}/d_t = 100 \text{ A/}\mu\text{s,}$ $I_S = -12 \text{ A}$			39		1
Discharge Time	t _b				21		1
Reverse Recovery Charge	Q _{RR}				0.13		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{3.} Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$ 4. Switching characteristics are independent of operating junction temperatures

TYPICAL PERFORMANCE CURVES

(T_J = 25°C unless otherwise noted)

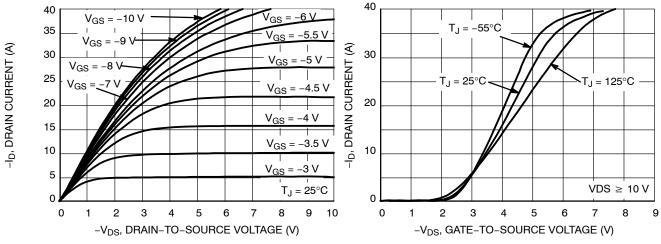


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

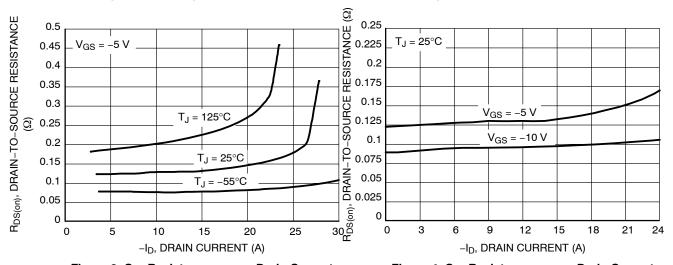


Figure 3. On-Resistance versus Drain Current and Temperature

Figure 4. On-Resistance versus Drain Current and Gate Voltage

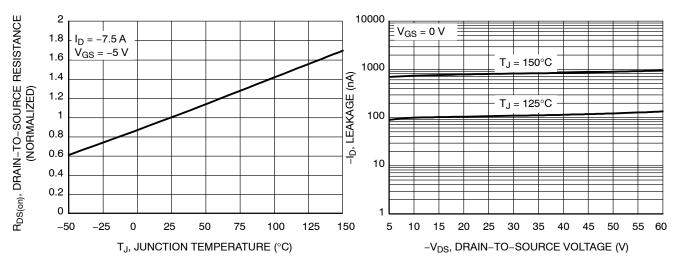
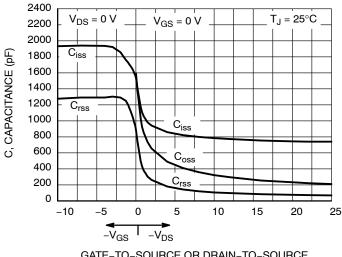


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current versus Voltage



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (V)

Figure 7. Capacitance Variation

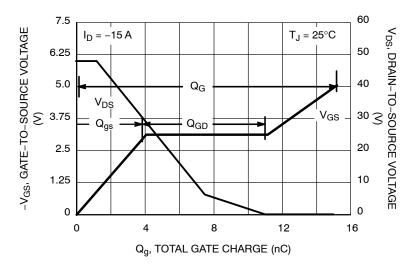
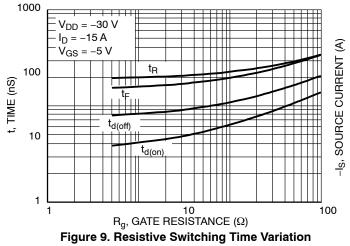


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge



versus Gate Resistance

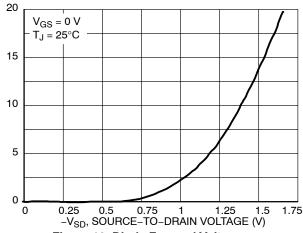


Figure 10. Diode Forward Voltage versus Current

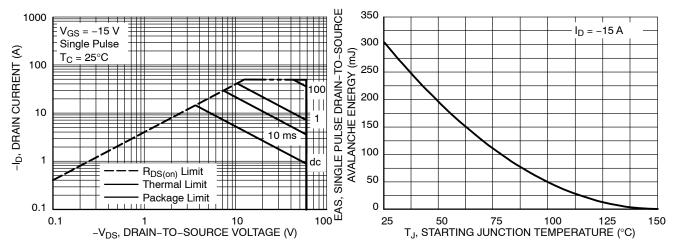
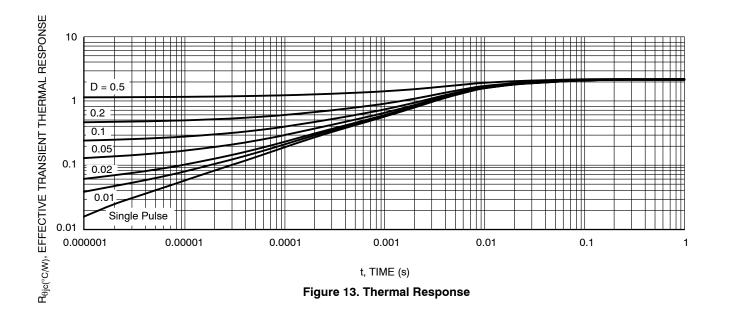


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. Maximum Avalanche Energy versus Starting Junction Temperature



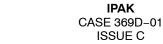
ORDERING INFORMATION

Device	Package	$Shipping^\dagger$	
NTD20P06LG	DPAK (Pb-Free)	75 Units / Rail	
NTD20P06LT4G		2500 / Tape & Reel	
NTDV20P06LT4G		2500 / Tape & Reel	
NTDV20P06LT4G-VF01		2500 / Tape & Reel	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE





STYLE 3: PIN 1. ANODE

2. CATHODE

4. CATHODE

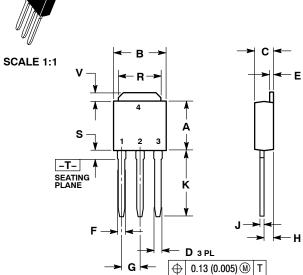
3 ANODE

STYLE 7: PIN 1. GATE 2. COLLECTOR

3. EMITTER

COLLECTOR

DATE 15 DEC 2010



STYLE 2:

PIN 1. GATE

3

STYLE 6: PIN 1. MT1 2. MT2 3. GATE

2. DRAIN

4. DRAIN

MT2

SOURCE

STYLE 1: PIN 1. BASE

3

STYLE 5: PIN 1. GATE

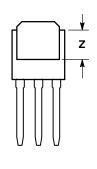
2. ANODE 3. CATHODE

ANODE

2. COLLECTOR

EMITTER

COLLECTOR



NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.35
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.090	BSC	2.29 BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.180	0.215	4.45	5.45
S	0.025	0.040	0.63	1.01
٧	0.035	0.050	0.89	1.27
Z	0.155		3.93	

MARKING DIAGRAMS

STYLE 4:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE
Discrete

XXXXX

ALYWW

XXXXXXXX

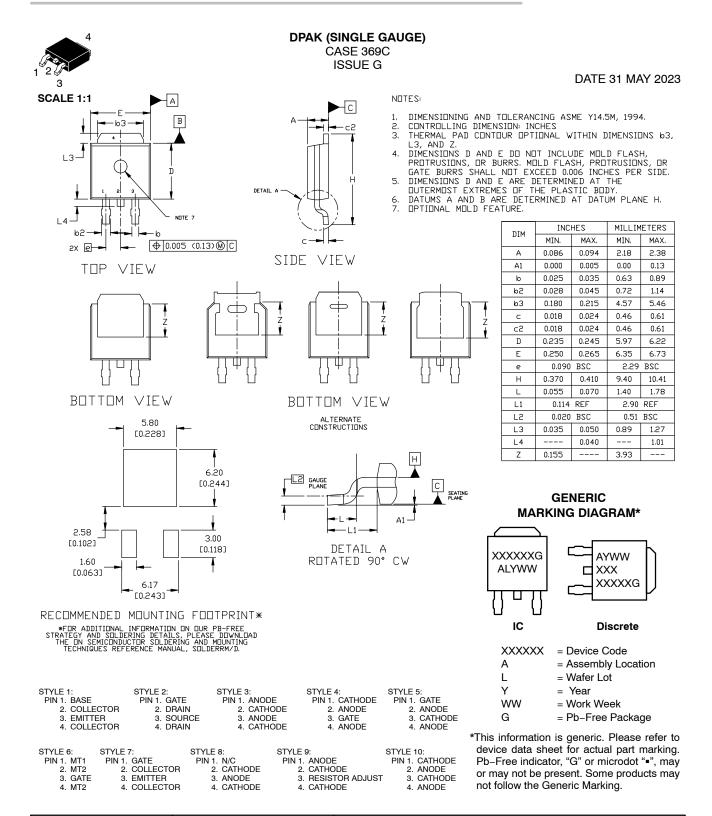
X

xxxxxxxxx = Device Code
A = Assembly Location
IL = Wafer Lot
Y = Year
WW = Work Week

	IPAK (DPAK INSERTION MOUNT)			
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